

# Surface Mount Standard Rectifiers

#### **Features**

- Low profile space
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering: 260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC





#### **Mechanical Date**

• Case: JEDEC DO-214AA molded plastic body over glass passivated chip

 Terminals: Solder plated, solderable per JESD22-B102

• Polarity: Laser band denotes cathode end

### Major Ratings and Characteristics

I <sub>F(AV)</sub>	2.0 A				
V <sub>RRM</sub>	50 V to 1000 V				
I <sub>FSM</sub>	50 A 5 μA				
I <sub>R</sub>					
V <sub>F</sub>	1.1 V				
T <sub>j</sub> max.	150 °C				

## **Maximum Ratings & Thermal Characteristics**

(T<sub>A</sub> = 25 °C unless otherwise noted)

Items	Symbol	S2A	S2B	S2D	S2G	S2J	S2K	S2M	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	2				Α			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50				Α			
Thermal resistance from junction to lead <sup>(1)</sup>	$R_{\theta JL}$	25					°C/W		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	–55 to +150					$^{\circ}\!\mathbb{C}$		

Note 1: Mounted on P.C.B. with 0.28 x 0.28" (7.0 x 7.0mm) copper pad areas.

### **Electrical Characteristics** (T<sub>A</sub> = 25 °C unless otherwise noted)

Items	Test conditions		Symbol	Min	Туре	Max	UNIT		
Instantaneous forward voltage	I <sub>F</sub> =2A <sup>(2)</sup>		$V_{F}$	-	0.98	1.10	V		
Reverse current	V <sub>R</sub> =V <sub>DC</sub>	T <sub>j</sub> =25℃ T <sub>j</sub> =125℃	I <sub>R</sub>	ı	-	5 50	μΑ		
Typical junction capacitance	4.0 V ,1MHz		CJ	-	30.0	-	pF		

Note 2: Pulse test:300µs pulse width,1% duty cycle.



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### Characteristic Curves (T<sub>A</sub>=25 ℃ unless otherwise noted)

Fig.1 Forward Current Derating Curve

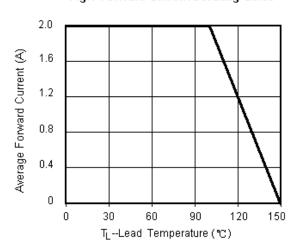


Fig.2 Maximum Non-Repetitive Peak
Forward Surge Current

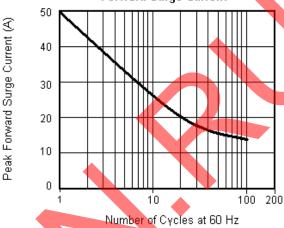


Fig.3 Typical Instantaneous Forward Characteristics

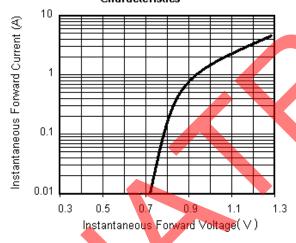
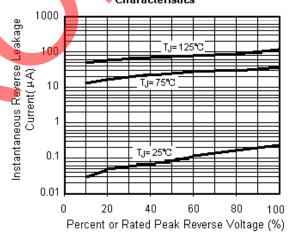


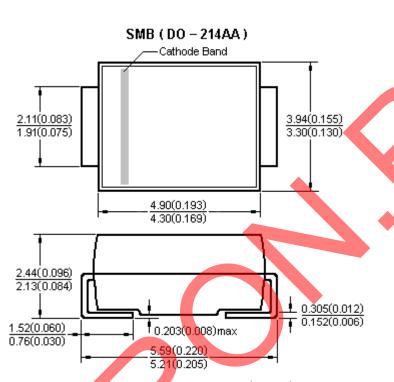
Fig.4 Typical Reverse Leakage Characteristics





# **Surface Mount Standard Rectifiers**

### **Package Outline**



### Dimensions in millimeters and (inches)

### **Notice**

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage.or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
  - IF(AV): We recommend that the worst case current be no greater than 80%.
  - T<sub>J</sub>: Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T<sub>J</sub> of below 125°C.
- TRR is registered trademark of Zhejiang TRR Microelectronics Inc. Zhejiang TRR Microelectronics Inc reserves the right to make changes to any product in this specification without notice.
- Zhejiang TRR Microelectronics Inc does not assure any liability arising out of the applications or use of any product described in this specification.
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